

jc825 U.S. PTO
10/057009

01/24/02

U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10057009	01 24 2002	438		2812	

****APPLICANTS:** Chen Wei-Su, Su Hui-Chi, Chen Yi-Shian, Lang Chao-Chiun, Lee Cheng, Juang Jeng

****CONTINUING DATA VERIFIED:** *None*

**** FOREIGN APPLICATIONS VERIFIED:** *None*

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input checked="" type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met	<input checked="" type="checkbox"/> yes <input checked="" type="checkbox"/> no	64 600-095
Verified and Acknowledged Examiner's initials <i>WJ</i>		
TITLE : Micro fabrication with vortex shaped spirally topographically tapered spirally patterned conductor layer and method for fabrication thereof		

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner	
		Application Examiner	
		PREPARED FOR ISSUE	
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